

Dual N-Channel MOSFET

General Description

The WSP8810A is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WSP8810A meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

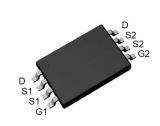
Product Summery

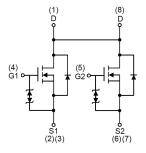
BVDSS	RDSON	ID		
20V	14.5mΩ	7.0A		

Applications

- High Frequency Point-of-Load Synchronous Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- ESD:2KV

TSSOP-8 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	20	V	
V_{GS}	Gate-Source Voltage	±12	V	
I _D @T _c =25℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	7.0	А	
I _D @T _c =70°C	Continuous Drain Current, V _{GS} @ 4.5V ¹	5.8	А	
I _{DM}	Pulsed Drain Current ²	20	А	
P _D @T _A =25℃	Total Power Dissipation ³	1.25	W	
T _{STG}	Storage Temperature Range -55 to 150		$^{\circ}$	
T_J	Operating Junction Temperature Range -55 to 150		$^{\circ}$	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient ¹		100	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		70	°C/W



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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25℃, I _D =1mA		0.022		V/°C
		V _{GS} =10V , I _D =7A		FIĚ	Œ	
		V_{GS} =4.5 V , I_D =7 A		FÍ	Œ	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =3.1V , I _D =5A		FÎ	G	mΩ
		V_{GS} =2.5 V , I_D =4 A		FΪĚ	Ĝ	
		V _{GS} =1.8V , I _D =2A		œ	H€	
$V_{GS(th)}$	Gate Threshold Voltage		0.4	0.7	1.0	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			-2.33		mV/℃
	Drain-Source Leakage Current	V_{DS} =16V , V_{GS} =0V , T_J =25 $^{\circ}$ C			1	uA
I _{DSS}		V_{DS} =16V , V_{GS} =0V , T_J =55 $^{\circ}$ C			5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 12V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V_{DS} =5V , I_D =5A		FH		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		4		Ω
Q_g	Total Gate Charge (4.5V)	V _{DS} =10V , V _{GS} =4.5V , I _D =6A		16	24.5	nC
Q_gs	Gate-Source Charge			ΙÈG	ì .0	
Q_gd	Gate-Drain Charge			ŒÎ	7.2	
$T_{d(on)}$	Turn-On Delay Time			16	10	
T _r	Rise Time	V_{DD} =10V , V_{GEN} =4.5V , R_G =6 Ω ,		0.8	26	ns
T _{d(off)}	Turn-Off Delay Time	I_D =1A ,RL=10 Ω .		30	55	
T _f	Fall Time			5	10	
C _{iss}	Input Capacitance	V _{DS} =10V , V _{GS} =0V , f=1MHz		FGJG		
C _{oss}	Output Capacitance			FÎΗ		pF
C _{rss}	Reverse Transfer Capacitance			ÌÍ		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current ^{1,4}	V =V =0V Force Current			2.0	Α
I _{SM}	Pulsed Source Current ^{2,4}	V _G =V _D =0V , Force Current			8.0	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1.5A , T _J =25℃			1.3	V
t _{rr}	Reverse Recovery Time			HF		nS
Q _{rr}	Reverse Recovery Charge	IF=6A , dI/dt=100A/ μ s , T $_{J}$ =25 $^{\circ}$ C		ÎĚ		nC

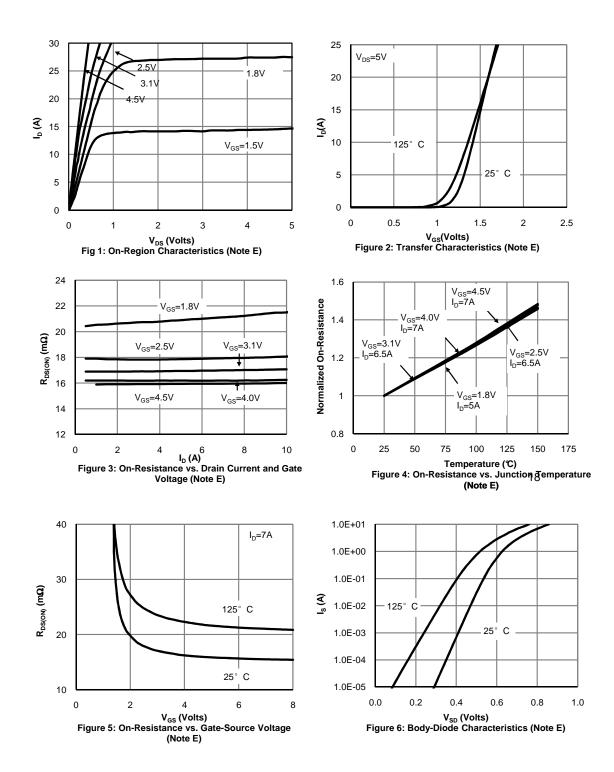
Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t≦10sec.
- 2.The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$
- 4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.





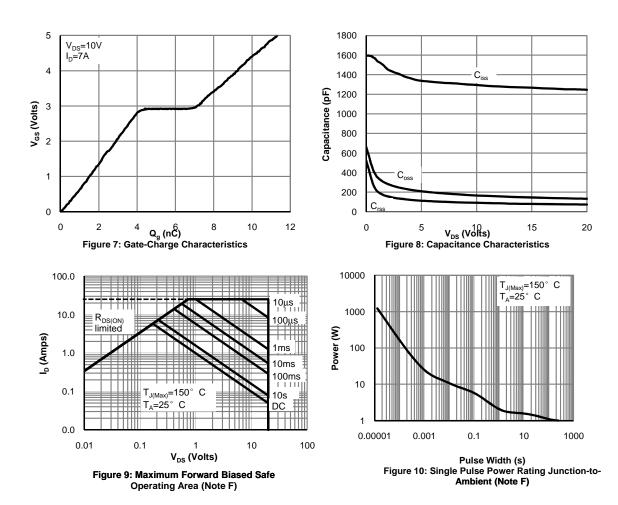
Typical Characteristics







Typical Characteristics



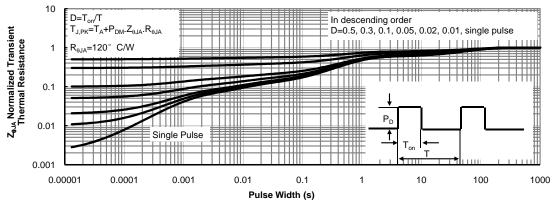


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)



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